



940nm 200mW CW VCSEL Diode

VCx-940C200A



Description

The Lasermate VCx-940C200A is an 940nm wavelength, 200mW output power, CW operating mode, Vertical Cavity Surface Emitting Laser (VCSEL) diode. Available in different package types, the VCSEL is characterized by its single longitudinal mode, low threshold current, and easy collimation. VCx-940C200A is designed for use in 3D sensor, gesture recognition, IR illumination, medical application, proximity sensors.

Features

- 940nm VCSEL Diode
- Output power: 200mW
- Single longitudinal mode
- Low wavelength drift
- Oxide isolation technology
- Low threshold current
- High reliability
- Easy to collimate

Applications

- 3D sensor
- Gesture recognition
- IR illumination
- Medical application
- Proximity sensor

Product Overview

The following table lists the available part numbers, as well as the package type of each of the part numbers.

Part Number	Package
VC20A-940C200A	2016 Package, Substrate AlN
VC35A-940C200A	3535 Package, Substrate AlN
VC20C-940C200A	2016 Package, Substrate CuAg
VCT5-940C200A	TO56 Package, Substrate NiFe

Specifications

Absolute Maximum Ratings				
Parameters	Symbol	Rating	Unit	Conditions
Case Operating Temperature	Top	-40 to 85	°C	
Storage Temperature	Tstg	-40 to 105	°C	
Reflow Soldering Temperature	Tsol	260	°C	10 seconds
Reverse Voltage	Vr	4	V	
Maximum Continuous Current	I _{max}	400	mA	
ESD Exposure (Human Body) Model	ESD	2K	V	

Notes:

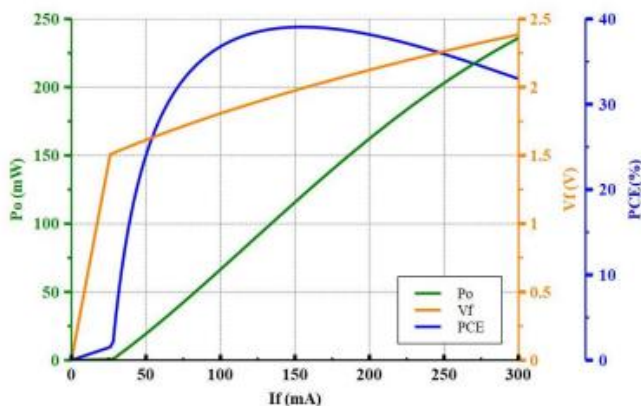
- Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions above those indicated in the operations section for expanded periods of time may affect reliability.
- In its maximum rating diode laser operation could damage its performance or cause potential safety hazard such as equipment failure.
- Electrostatic discharge is the main reason for laser fault of the diode. Take effective precautions against ESD. When dealing with laser diodes, use wrist strap, grounding work surface and strict antistatic technology.

Electro-Optical Characteristics (T _{op} =25°C, CW mode)						
Parameters	Symbol	Min.	Typ.	Max.	Unit	Conditions
Optical Output Power	P _o	-	200	-	mW	I _F =250mA
Threshold Current	I _{th}	-	25	-	mA	
Forward Current	I _F	-	250	-	mA	
Slope Efficiency	η	-	0.9	-	W/A	P _o =200mW
Power Conversion Efficiency	PCE	-	35	39	%	I _F =250mA
Peak Wavelength	λ _P	930	940	950	nm	I _F =250mA
Laser Forward Voltage	V _F	-	2.3	-	V	I _F =250mA
Series Resistance	R _S	-	3.4	-	Ω	I _F =250mA
Beam Divergence	FWHM _B	-	16	-	deg	I _F =250mA
	(1/e ²)	-	20	-		
Wavelength Temperature Drift	Δλ _P / ΔT	-	-	0.07	nm/°C	I _F =250mA
No. of Emission Aperture		-	20	-		

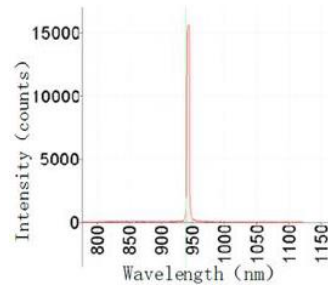
Note: Electro-optical characteristic with a package or diffuser would require further evaluation. Values are based on limited sample size and estimated values.

Typical Characteristics

LIV Graph

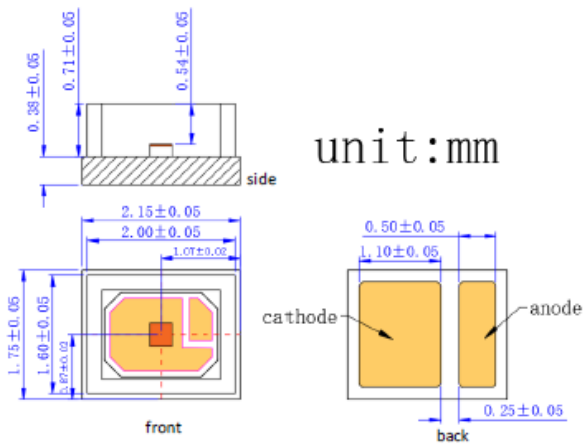


Intensity vs. Wavelength

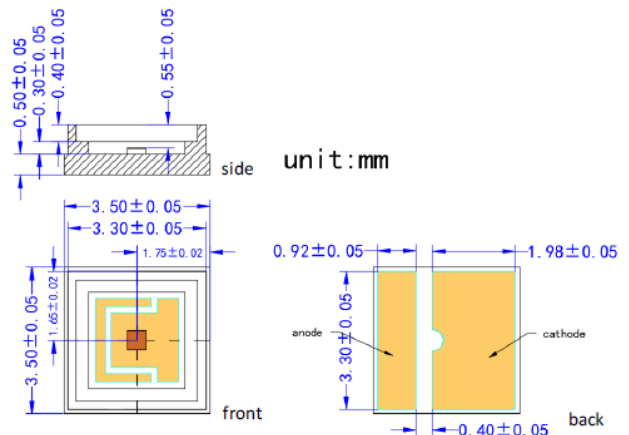


Outline Dimensions (unit: mm)

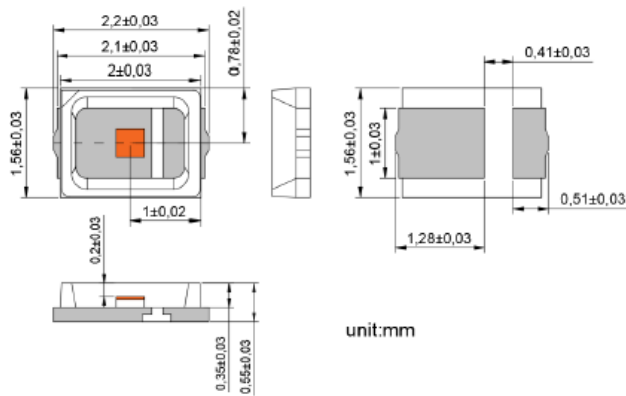
VC20A-940C200A (2016 SMD Package, Substrate AlN)



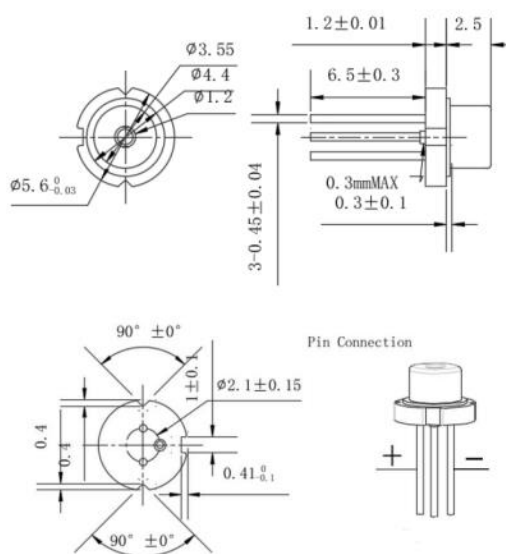
VC35A-940C200A (3535 SMD Package, Substrate AlN)



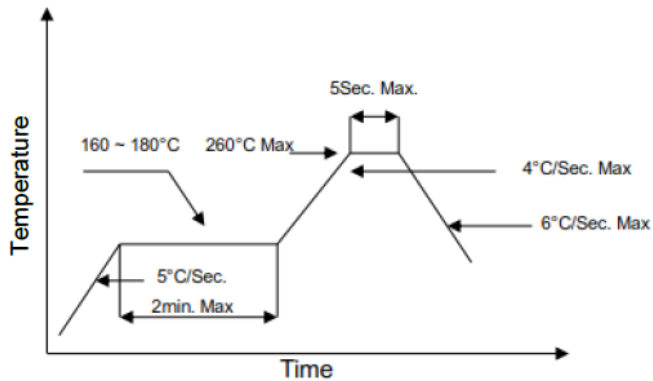
VC20C-940C200A (2016 SMD Package, Substrate CuAg)



VCT5-940C200A (TO-56 Package, Substrate NiFe)



SMT Reflow Soldering Curve



Note: Reflow soldering can be operated only one time. During the temperature ramp-up, no forces may be exerted on the LD which would deform or damage them. After soldering is completed, please do not process until the product temperature ramps down to room temperature.

Additional Notes

1. Please use solder paste to cure the laser diode.
2. Please make sure that the heat of VCSEL diode has been completely conducted to metal shell to avoid affecting the optical power output.
3. This VCSEL diode can be only used in constant voltage and current.
4. Please do not aim the laser at people or animals.
5. You may observe the laser spot through an image monitoring equipment.
6. Please do not touch VCSEL diode surface by naked hands or squeeze the sealant on VCSEL diode surface. It may cause wrong optical angle and distorted laser spot, and even damage the VCSEL diode.
7. Please use ceramic suction nozzle to absorb the VCSEL diode, so as to avoid VCSEL diode sticking to the nozzle.
8. Please add a 0.02s blowing action after locating the laser diode to aluminum substrate.
9. Specifications are subject to change without notice.



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